Application No. 10/632,549 Attorney Docket: <u>CPAC 1017-2</u>



in re application of: Marcos Karnezos

Application No.: 10/632,549

Filed: August 2, 2003

Title: Semiconductor multi-package module having wire bond interconnect between stacked

packages

Attorney Docket No.: CPAC 1017-2

Examiner: Phat X. CAO

Group: 2811

Confirmation No.: 2569

Customer No. 22470

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO/SB/08A. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98. However, since this application was filed after June 30, 2003, copies of U. S. Patents and U. S. Patent Application Publications are not enclosed. (See O. G. Notice of August 5, 2003.)

This statement should be considered under 37 C.F.R. 1.97(c) because it is being filed before the mailing date of a FINAL office action, a Notice of Allowance, or an action that otherwise closes prosecution in the subject application, whichever occurs first, AND:

This statement is accompanied by the \$180 fee set forth in 37 C.F.R. 1.17(p).

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Application No. 10/632,549 Attorney Docket: <u>CPAC 1017-2</u>

Fee Authorization. The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1017-2).

Respectfully submitted,

Haynes Beffel & Wolfeld LLP

Date: 12 Api / 201

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 1 of 1

Complete if Known					
Application Number	10/632,549				
Filing Date	08/02/03				
First Named Inventor	Karnezos				
Group Art Unit	2811				
Examiner Name	Phat X. Cao				
Attorney Docket Number	CPAC 1017-2	7			

	U.S. PATENT DOCUMENTS								
Examiner Initials*	Cite No.1	Number	nent Code ² nown)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear			
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	A2	5,495,398		Takiar et al.	02-27-1996				
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	A19								
	A20								

	FOREIGN PATENT DOCUMENTS									
		F	oreign Patent Do	cument	Name of Patentee or	Date of Publication of	Pages, Columns, Lines, Where Relevant			
Examiner Cite Initials No.1		Office ³	Number ⁴	Kind Code ⁵ (if known)	Applicant of Cited Document	Cited Document MM-DD-YYYY	Passages or Relevant Figures Appear	T ⁶		
	B1									
	B2									
	В3									
	В4									
	B5									
	· B6									
	В7									
	B8									
	В9									
	B10			4						

Examiner		Date	
Signature	į (Considered	

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.